2SD1423, 2SD1423A

Silicon NPN epitaxial planer type

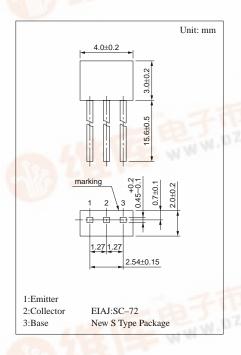
For low-frequency amplification Complementary to 2SB1030 and 2SB1030A

Features

- Optimum for high-density mounting.
- Allowing supply with the radial taping.

Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to	2SD1423	17	30	V	
base voltage	2SD1423A	V_{CBO}	60		
Collector to	2SD1423	**	25	V	
emitter voltage	2SD1423A	V_{CEO}	50		
Emitter to base voltage		V_{EBO}	7	V	
Peak collector current		I_{CP}	1	A	
Collector current		I_C	0.5	A	
Collector power dissipation		P_{C}	300	mW	
Junction temperature		T_{j}	150	°C	
Storage temperature		T_{stg}	−55 ~ +150	°C	



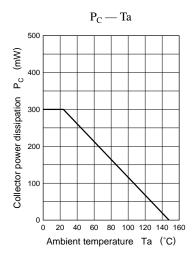
Electrical Characteristics (Ta=25°C)

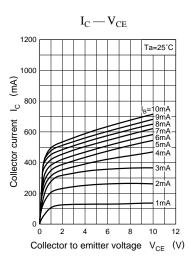
Parameter		Symbol	Conditions	min	typ	max	Unit
Collector cutoff current		I_{CBO}	$V_{CB} = 20V, I_{E} = 0$			0.1	μА
		I_{CEO}	$V_{CE} = 20V, I_{B} = 0$			1	μА
Collector to base	2SD1423	**	$I_C = 10 \mu A, I_E = 0$	30		112	V
voltage	2SD1423A	V _{CBO}		60			
Collector to emitter	2SD1423	V _{CEO}	$I_C = 2mA$, $I_B = 0$	25		- 4	V
voltage	2SD1423A			50			
Emitter to base voltage		V _{EBO}	$I_{\rm E} = 10 \mu A, I_{\rm C} = 0$	7			V
Forward current transfer ratio		h _{FE1} *1	$V_{CE} = 10V, I_C = 150 \text{mA}^{*2}$	85		340	
		h _{FE2}	$V_{CE} = 10V, I_C = 500 \text{mA}^{*2}$	40			
Collector to emitter saturation voltage V _{CE(sat)}		$I_C = 300 \text{mA}, I_B = 30 \text{mA}^{*2}$			0.6	V	
Transition frequency f _T		f_{T}	$V_{CB} = 10V, I_E = -50mA, f = 200MHz$		200		MHz
Collector output capacitance		C _{ob}	$V_{CB} = 10V, I_E = 0, f = 1MHz$		6	15	pF

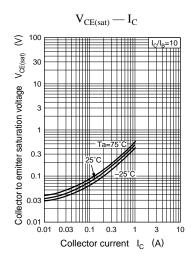
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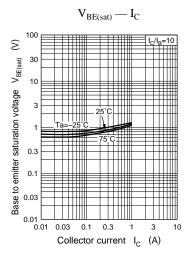
*2 Pulse measurement

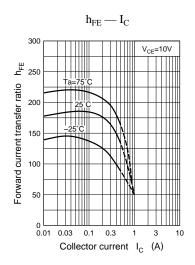


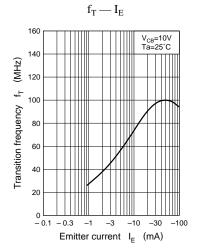


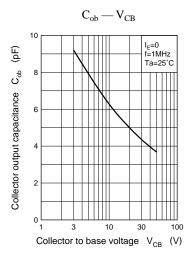












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